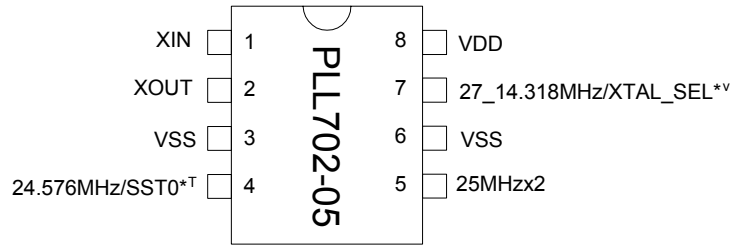


**Low EMI Peripheral Clock Generator for Notebook**

**FEATURES**

- Single Low EMI IC to replace multiple crystals and oscillators on Notebooks (27MHz, 14.318MHz, 24.576MHz, 25MHz).
- Selectable crystal input: 24.576MHz or 14.318MHz (accuracy requirement +/- 20ppm)
- Less than 10ppm Frequency Synthesis error, meeting AC97, IEEE1394, IEEE802 frequency precision specification.
- 27MHz clock with 2 levels of Selectable Spread Spectrum modulation +/- 0.5% and +/- 0.75% center.
- 25MHz clock with double drive strength (Ethernet PHY and MAC).
- 24.576MHz clocks for Audio Codec and IEEE1394.
- Available in 8-Pin SOIC.

**PIN ASSIGNMENT**



**Note:** 25MHzx2: double drive strength      \*: Bi-directional pin  
 V: Internal pull-down resistor (120kΩ)      †: Tri-level input

**POWER GROUPS**

- VDD – VSS: XIN, XOUT, analog core, digital part, 27MHz., 24.576MHz and 25MHz.

**Table 1. SPREAD SPECTRUM SELECTION**

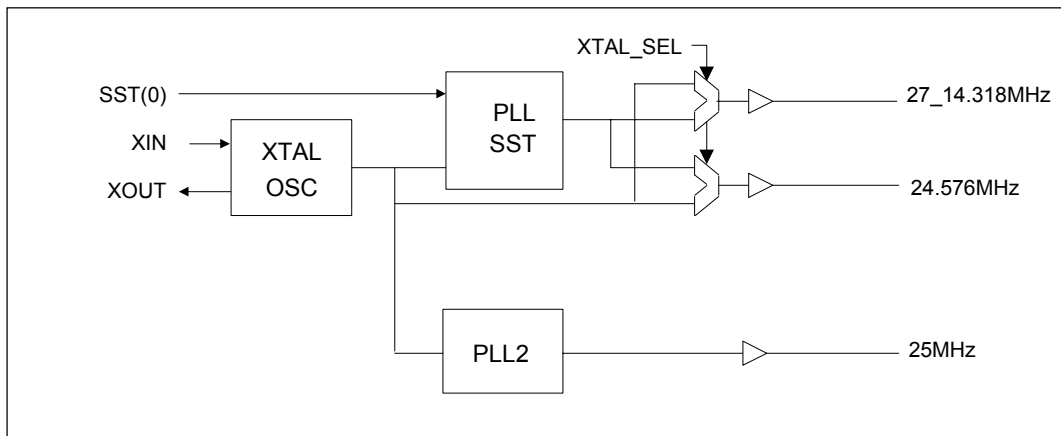
SST0	SST Modulation only on 27MHz. (pin 7)
1	+/- 0.75 %
0	+/- 0.5 %
M	SST OFF (Default)

Notes: M = Do not connect. 1 = Pulled up. 0 = Pulled down.

**Table 2. CRYSTAL SELECTION TABLE**

Crystal Input	XTAL_SEL	Pin 7
24.576MHz	0	27MHz
14.318MHz	1	14.318MHz

**BLOCK DIAGRAM**



**Note :** Only 27MHz output is modulated for low EMI via Spread Spectrum.

## Low EMI Peripheral Clock Generator for Notebook

### PIN DESCRIPTIONS

Name	Pin#	Type	Description
XIN	1	I	Crystal input: accepts either 24.576MHz or 14.31818MHz fundamental crystal (CL = 20pF, parallel resonant mode, +/-20ppm). On-chip load capacitors: no external load capacitors required. (See the table #4 )
XOUT	2	O	Crystal output.
VSS	3,6	P	Ground connection.
24.576MHz/SST0	4	B	Bi-directional and Tri-Level pin. Upon power-on, the value of SST0 is latched in and used to select the SST control (see Spread Spectrum selection table 1). Tri level input: M = Do not connect, 1 = Pull up, 0 = Pull down. After power-up this pin acts as 24.576MHz output clock.
25MHzx2	5	O	25MHz Ethernet output clock (double drive strength).
27_14.318MHz/XTAL_SEL	7	B	Bi-directional pin. Upon power-on, the value of XTAL_SEL is latched in and used to set the input crystal frequency (24.575MHz or 14.31818MHz). Set XTAL_SEL to 0 (default) for 24.576MHz input crystal, set XTAL_SEL to 1 for 14.31818MHz input crystal (see Crystal Selection Table on page 1). . After power-up this pin acts as 27MHz output (with 24.576MHz crystal) or as 14.31818MHz pass through clock (with 14.31818MHz crystal), depending on the input crystal. The 27MHz output can be modulated for low EMI using Spread Spectrum.
VDD	8	P	3.3V power supply for 27MHz, oscillator, analog core and digital circuitry.

### FUNCTIONAL DESCRIPTION

#### Tri-level and two-level inputs

In order to reduce pin usage, the PLL702-05 uses tri-level input pins. These pins allow 3 levels for input selection: namely, 0 = Connect to GND, 1 = Connect to VDD, M = Do not connect. Thus, unlike the two-level selection pins, the tri-level input pins are in the "M" (mid) state when not connected. In order to connect a tri-level pin to a logical "zero", the pin must be connected to GND. Likewise, in order to connect to a logical "one", the pin must be connected to VDD.

#### Connecting a bi-directional pin

The PLL702-05 also uses bi-directional pins. The same pin serves as input upon power-up, and as output as soon as the inputs have been latched. The value of the input is latched-in upon power-up. Depending on the pin (see pin description), the input can be tri-level or a standard two-level. Unlike unidirectional pins, bi-directional pins cannot be connected directly to GND or VDD in order to set the input to "0" or "1", since the pin also needs to serve as output. In the case of two level input pins, an internal pull-up resistor is present. This allows a default value to be set when no external pull down resistor is connected between the pin and GND (by definition, a tri-level input has a the default value of "M" (mid) if it is not connected). In order to connect a bi-directional pin to a non-default value, the input must be connected to GND or VDD through an external pull-down/pull-up resistor.

**Note:** when the output load presents a low impedance in comparison to the internal pull-up resistor, the internal pull-up resistor may not be sufficient to pull the input up to a logical "one", and an external pull-up resistor may be required.

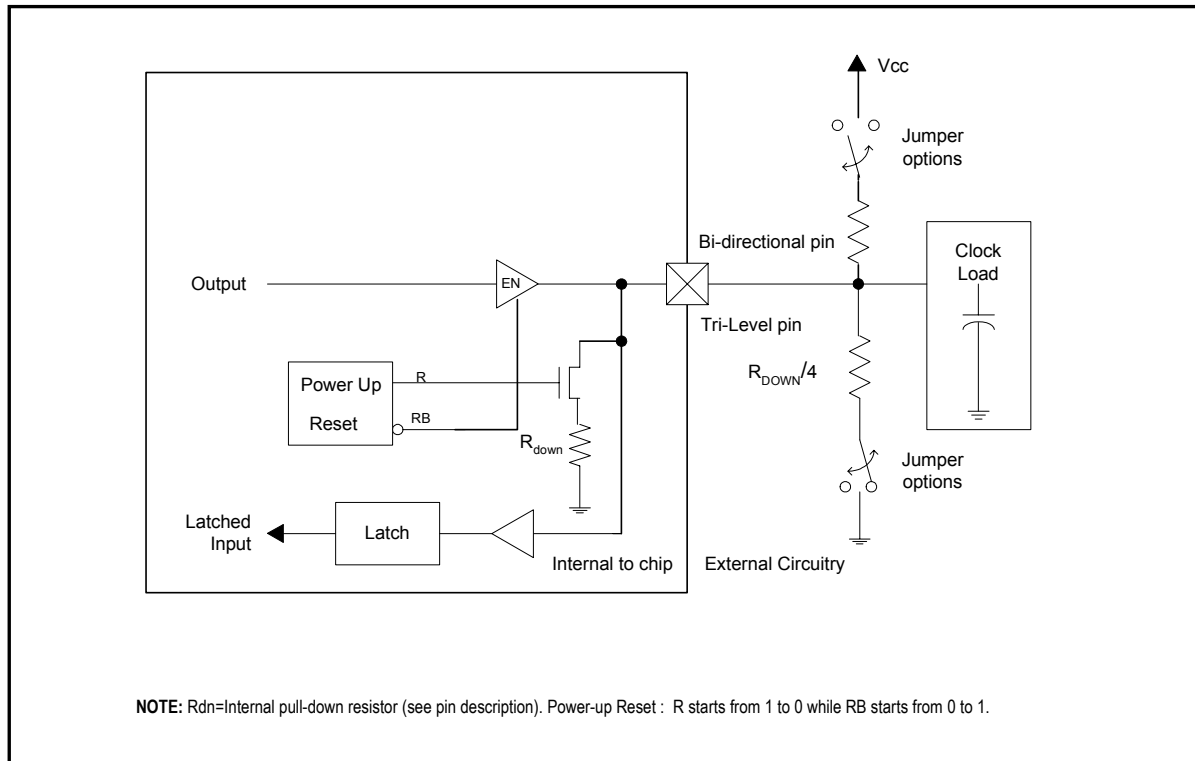
For bi-directional inputs, the external loading resistor between the pin and GND has to be sufficiently small (compared to the internal pull-up resistor) so that the pin voltage be pulled below 0.8V (logical "zero"). In order to avoid loading effects when the pin serves as output, the value of the external pull-down resistor should however be kept as large as possible. In general, it is

**Low EMI Peripheral Clock Generator for Notebook**

recommended to use an external resistor of around one sixth to one quarter of the internal pull-up resistor (see Application Diagram).

**Note:** when the output is used to drive a load presenting an small resistance between the output pin and VDD, this resistance is in essence connected in parallel to the internal pull-up resistor. In such a case, the external pull-down resistor may have to be dimensioned smaller to guarantee that the pin voltage will be low enough achieve the desired logical "zero". This is particularly true when driving 74FXX TTL components.

**APPLICATION DIAGRAM: BI-DIRECTIONAL PINS WITH INTERNAL PULL-DOWN**



## Low EMI Peripheral Clock Generator for Notebook

### Electrical Specifications

#### 1. Absolute Maximum Ratings

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage	$V_{DD}$		4.6	V
Input Voltage, dc	$V_I$	-0.5	$V_{DD}+0.5$	V
Output Voltage, dc	$V_O$	-0.5	$V_{DD}+0.5$	V
Storage Temperature	$T_S$	-65	150	°C
Ambient Operating Temperature*	$T_A$	-40	85	°C
Junction Temperature	$T_J$		125	°C
Lead Temperature (soldering, 10s)			260	°C
ESD Protection, Human Body Model			2	kV

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

\* **Note:** Operating Temperature is guaranteed by design for all parts (COMMERCIAL and INDUSTRIAL), but tested for COMMERCIAL grade only.

#### 2. AC Specifications

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Frequency (to be set via XTAL_SEL)	+/- 20ppm accuracy		14.31818		MHz
			24.576		MHz
Output Rise Time	10% to 90% with no load			0.5	ns
Output Fall Time	90% to 10% with no load			0.5	ns
Duty Cycle	At $V_{DD}/2$	40	50	60	%
Max. Absolute Period Jitter	Long term, No SST			500	ps
Max. Jitter, cycle to cycle	Long term + Short term			400	ps
Clock Settle Time			22	25	ms
Crystal Load Capacitance	Excluding PCB parasitics		21		pF
Crystal ESR				30	$\Omega$

## Low EMI Peripheral Clock Generator for Notebook

### 3. DC Specifications

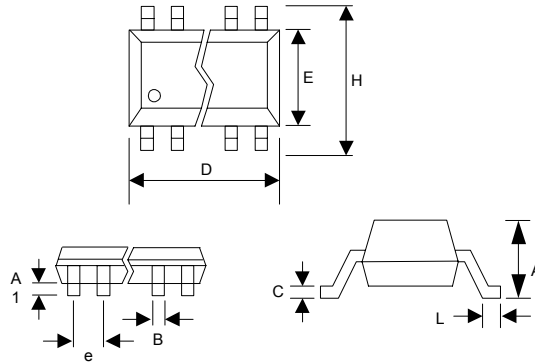
PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating Voltage	$V_{DD}$	Nominal voltage 3.3V	2.97		3.63	V
Input High Voltage	$V_{IH}$			$V_{DD}/2$		V
Input Low Voltage	$V_{IL}$			$V_{DD}/2$	$V_{DD}/2 - 1$	V
Input High Voltage	$V_{IH}$	For all Tri-level input	$V_{DD}-0.5$			V
Input Low Voltage	$V_{IL}$	For all Tri-level input			0.5	V
Input High Voltage	$V_{IH}$	For all normal input	2			V
Input Low Voltage	$V_{IL}$	For all normal input			0.8	V
Output High Voltage	$V_{OH}$	$I_{OH} = -10\text{mA}$ (normal drive)	2.4			V
		$I_{OH} = -20\text{mA}$ (double drive)				
Output Low Voltage	$V_{OL}$	$I_{OL} = 10\text{mA}$ (normal drive)			0.4	V
		$I_{OL} = -20\text{mA}$ (double drive)				
Output High Voltage At CMOS Level	$V_{OH}$	$I_{OH} = -8\text{mA}$	$V_{DD}-0.4$			V
Nominal Output Current	$I_{OUT}$	Normal drive strength	10			mA
		Double drive strength	20			
Operating Supply Current	$I_{DD}$	No Load		23		mA
Short-circuit Current	$I_S$			$\pm 100$		mA

**Low EMI Peripheral Clock Generator for Notebook**

**PACKAGE INFORMATION**

8 PIN Narrow SOIC ( mm )

Symbol	SOIC	
	Min.	Max.
A	1.55	1.73
A1	0.10	0.25
B	0.33	0.48
C	0.19	0.25
D	4.80	4.98
E	3.81	3.99
H	5.08	6.20
L	0.41	0.89
e	1.27 BSC	

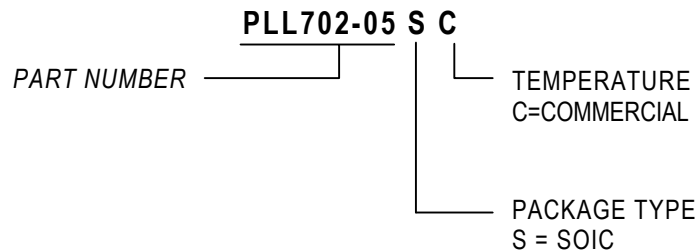


**ORDERING INFORMATION**

**For part ordering, please contact our Sales Department:**  
47745 Fremont Blvd., Fremont, CA 94538, USA  
Tel: (510) 492-0990 Fax: (510) 492-0991

**PART NUMBER**

The order number for this device is a combination of the following:  
Device number, Package type and Operating temperature range



Order Number	Marking	Package Option
PLL702-05SC-R	P702-05SC	SOIC -Tape and Reel
PLL702-05SC	P702-05SC	SOIC -Tube

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